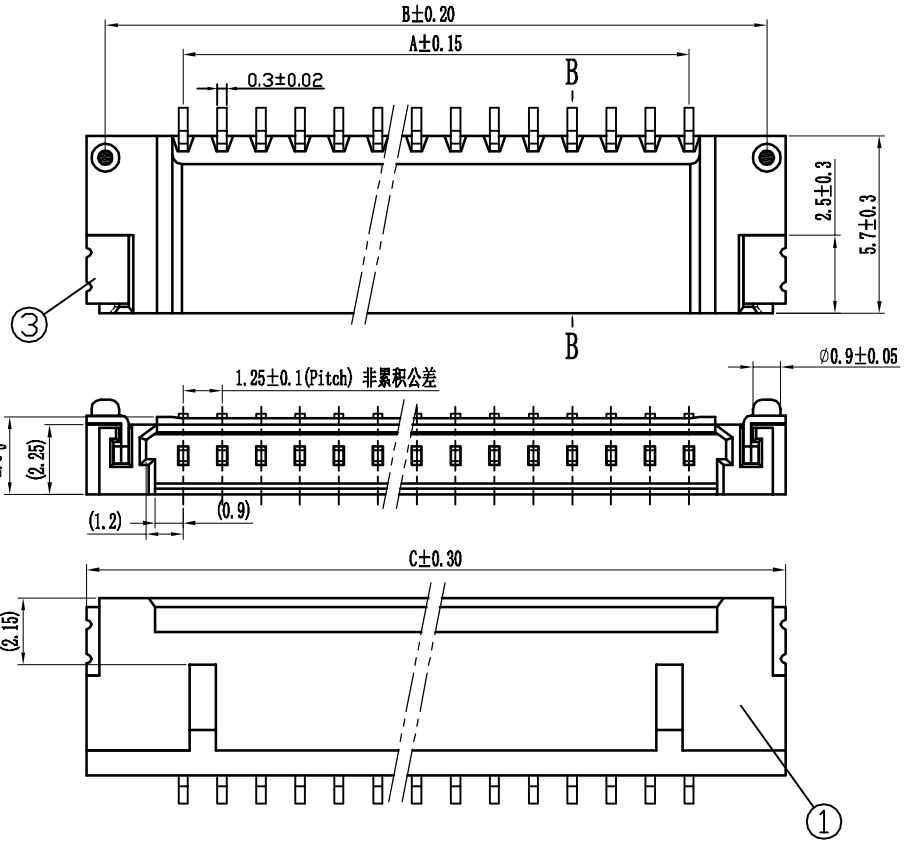
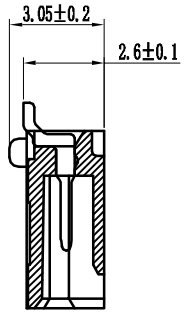
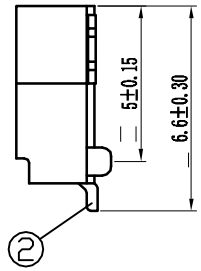


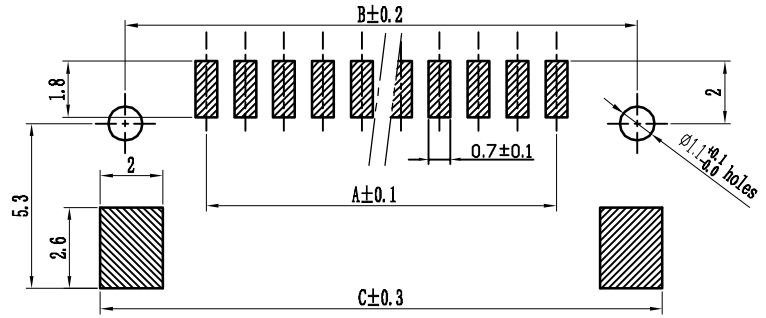


B-B



技术指标:
1、塑件表面应光洁、无毛刺、明显收缩、缺陷、裂纹等现象;
2、温度范围: -25° C~85° C;
3、额定电压: 200V, AC, DC(等效);
4、接触电阻: ≤0.03Ω;
5、绝缘电阻: ≥1000MΩ;
6、耐压: 1000V, AC/minute.

Pin位	A	B	C
3	2.5	7.7	8.7
4	3.75	8.95	9.95
5	5	10.2	11.2
6	6.25	11.45	12.45
7	7.5	12.7	13.7
8	8.75	13.95	14.95
9	10	15.2	16.2
10	11.25	16.45	17.45
11	12.5	17.7	18.7
12	13.75	18.95	19.95
13	15	20.2	21.2
14	16.25	21.45	22.45
15	17.5	22.7	23.7
16	18.75	23.95	24.95
17	20	25.2	26.2
18	21.25	26.45	27.45
19	22.5	27.7	28.7
20	23.75	28.95	29.95
21	25	30.2	31.2
22	26.25	31.45	32.45
23	27.5	32.7	33.7
24	28.75	33.95	34.95
25	30	35.2	36.2
26	31.25	36.45	37.45
27	32.5	37.7	38.7
28	33.75	38.95	39.95
29	35	40.2	41.2
30	36.25	41.45	42.45



PCB Layout

序号	名 称	材 料	数 量	附 注
3	焊片 Fitting Nail	磷青铜 Phosphor Bronze	2	电镀(铜): 整个表面镀底镍30u"MIN,再镀镍 80u"MIN.
2	端子 Contact	磷青铜 Phosphor Bronze	n×1	电镀(铜): 整个表面镀底镍30u"MIN,再镀镍 80u"MIN.
1	基座 Wafer	PA9T(UL94V-0)	1	本色

UNITS: mm		CSCONN	CSCONN PRECISE ELECTRONICS CO.,LTD
GENERAL TOLERANCE		PART NO.(INTENDED USE) CWF1250126X001	TITLE: WAFER 1.25MM XP SMT H2.6MM
X.° ±5°	0.X±0.25	APPD:	DWG NO. WAFER
X.1±2°	0.XX±0.2	CHKD: Skila	SCALE 1:1 / SHEET 1 OF 1 / REV A
XX. ±1°	0.XXX±0.1	DR: Kitty	